

PDP92406BT14

SMD Type Photodiode with Daylight Filter

Features

- Small double-end package
- High reliability
- High Reverse Breakdown
- High Sensitivity
- Spectral range of sensitivity: 700-1100nm
- Fast Response time
- RoHS compliance

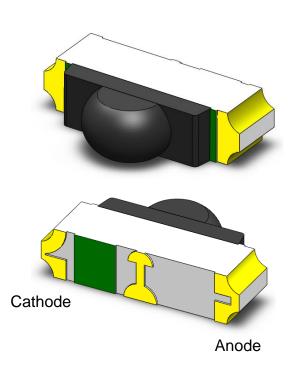
Applications

- Infrared sensor
- Light barrier
- Infrared Touch Panel Solutions

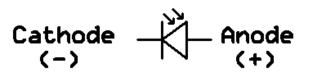
Description

The PDP92406BT14 is a silicon photo diode housed in a miniature SMD package. The device comes with a superior filtering for visible light by utilizing special black molding compound.

Package Outline



Schematic





Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
VR	Reverse Voltage	33	V	
T _{opr}	Operating Temperature	-40 ~ +85	٥C	
T _{stg}	Storage Temperature	-40 ~ +100	٥C	
T _{sol}	Soldering Temperature	260	٥C	1
PD	Power Dissipation at(or below) 25°C Free Air Temperature	138	mW	
Rтнја	Junction to Ambient Thermal Resistance	540	°C/W	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
λ	Spectral Bandwidth	-	700	-	1100	nm	
λρ	Peak Sensitivity	-	-	900	-	nm	
01/2	View Angle at X axis		-	±52.5	-	dog	2
θ1/2	View Angle at Y axis	V _R =5V	-	±32.5	-	deg	2

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes					
1-	Dark Current	Ee=0mW /cm ²								10	24	
ID	Dark Current	V _R =10V	-	-	10	nA						
	Dovorao Brookdown Voltogo	Ee=0mW /cm ²	22	210	-	V						
VBR	Reverse Breakdown Voltage	I _R =100uA	33									
Voc	Open-Circuit Voltage	Ee=1mW /cm ²	-	0.3	-	V						
I _{SC}	Short-Circuit Current	λ _P =940nm	-	1.0	-	μA						
1	Povereo Light Current	Ee=1mW /cm ²	1.0	4 47		μA						
IRL	Reverse Light Current	$\lambda_P=940nm, V_R=5V$		1.47	-							
C-	Transition Consoltance	Ee=0mW /cm ²		1 5 2		ъĘ						
C⊤	Transition Capacitance	f=1MHz ,V _R =5V	-	1.53	-	pF						

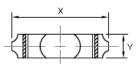


Switching Characteristics

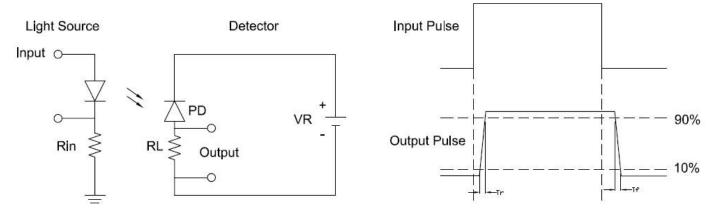
	Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
ſ	tr	Rise Time		-	230	-		0
	t _f	Fall Time	$V_R = 10V, R_L = 10k\Omega$	-	200	-	ns	3

Notes:

- 1 : Soldering time \leq 5 seconds.
- 2 : Test conditions :



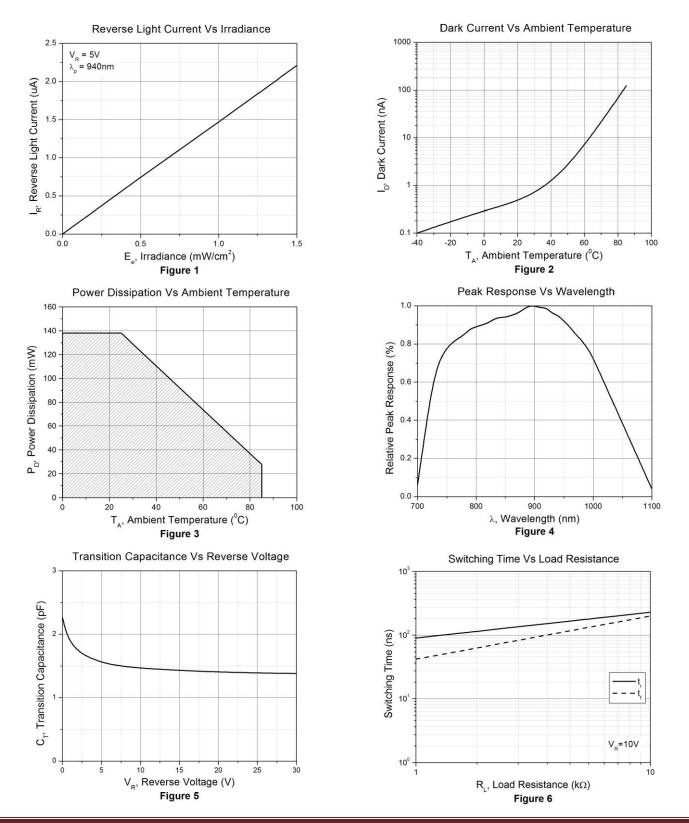
3 : Test circuit :



Switching Time

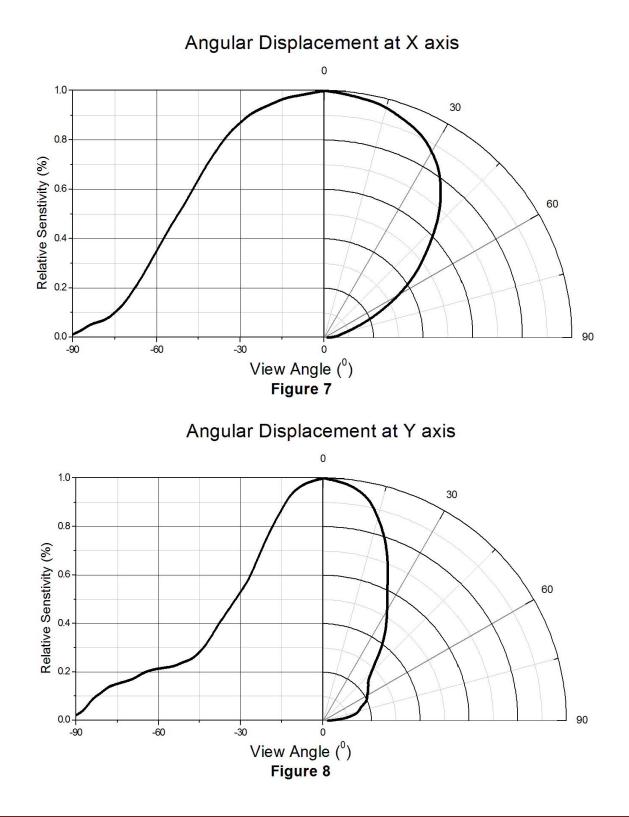


Typical Characteristic Curves



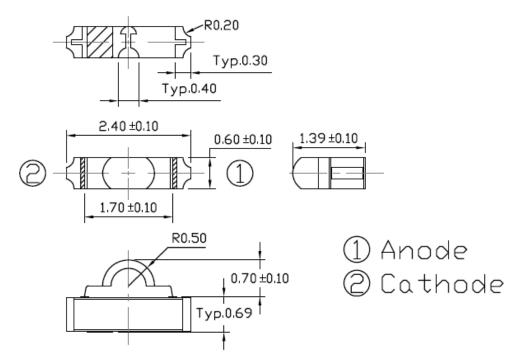


Typical Characteristic Curves

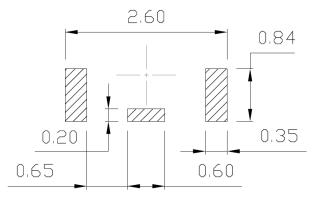




Package Dimension All dimensions are in mm, unless otherwise stated



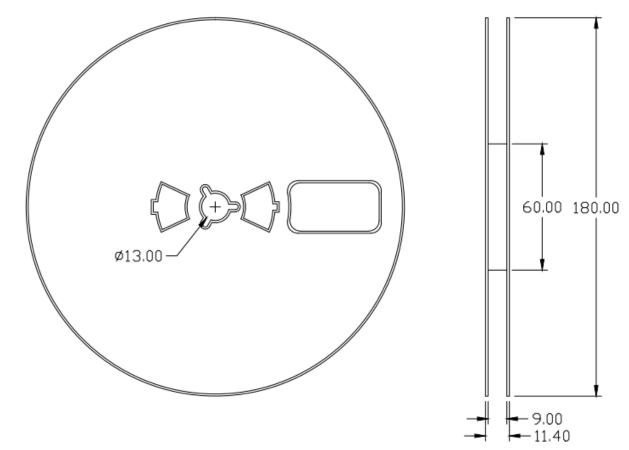
Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



Ordering Information

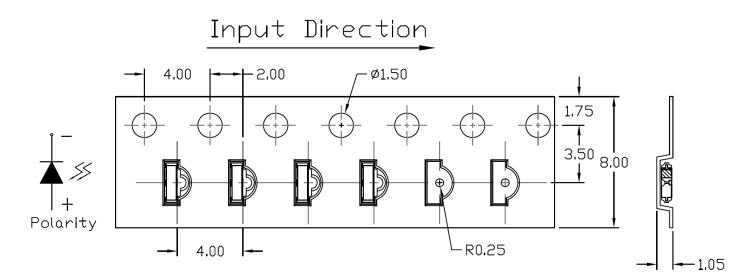
Part Number	Description	Quantity
PDP92406BT14	Tape & Reel	5000 pcs





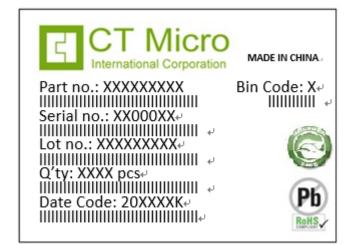
Reel Dimension All dimensions are in mm, unless otherwise stated

Tape Dimension All dimensions are in mm, unless otherwise stated





Label Form Specification



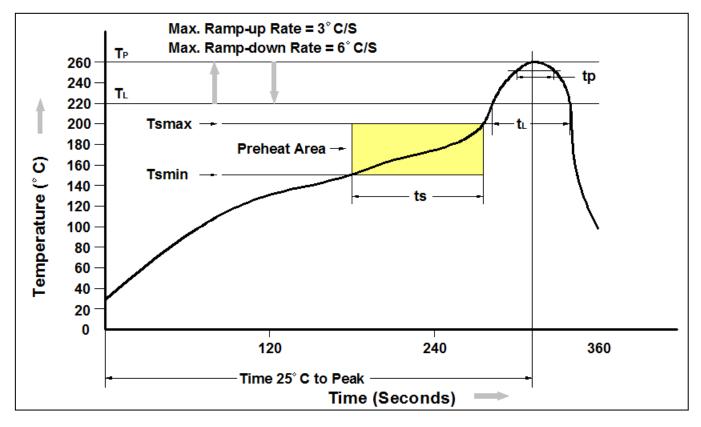
Part no: CTM Production Number Serial no: Production Number Lot no: Lot number Q'ty: Packing Quantity Date Code: Manufacture Date Bin Code: I_{RL} Ranks MADE IN CHINA: Production Place

Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t _P)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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